

# UNISONIC TECHNOLOGIES CO., LTD

15N50-MH **Power MOSFET** 

# **15A, 500V N-CHANNEL POWER MOSFET**

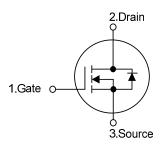
#### DESCRIPTION

The UTC 15N50-MH is a high voltage power MOSFET combines advanced planar MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

#### **FEATURES**

- \*  $R_{DS(ON)} \le 0.45 \Omega$  @  $V_{GS}=10V$ ,  $I_D=7.5A$
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness

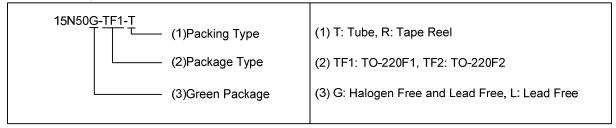
#### **SYMBOL**



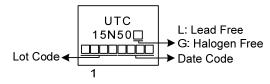
# **ORDERING INFORMATION**

Ordering Number		Doolsons	Pin	Daskins			
Lead Free	Halogen Free	Package	1	2	3	Packing	
15N50L-TF1-T	15N50G-TF1-T	TO-220F1	G	D	S	Tube	
15N50L-TF2-T	15N50G-TF2-T	TO-220F2	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



#### **MARKING**



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TO-220F1

TO-220F2

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# ■ ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub>=25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	$V_{DSS}$	500	<b>&gt;</b>
Gate-Source Voltage	$V_{GSS}$	±30	V
Continuous Drain Current	I <sub>D</sub>	15	Α
Pulsed Drain Current (Note 2)	I <sub>DM</sub>	30	Α
Avalanche Energy Single Pulsed (Note 3)	E <sub>AS</sub>	397	mJ
Peak Diode Recovery dv/dt (Note 4)	dv/dt	5.2	V/ns
Power Dissipation	$P_D$	40	W
Junction Temperature	TJ	+150	°C
Storage Temperature	T <sub>STG</sub>	-55 ~ <b>+</b> 150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 1.0mH,  $I_{AS}$  = 28.2A,  $V_{DD}$  = 50V,  $R_{G}$  = 25  $\Omega$ , Starting  $T_{J}$  = 25  $^{\circ}$ C
- 4.  $I_{SD} \le 15 A$ , di/dt  $\le 200 A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25 ^{\circ}C$

#### **■ THERMAL DATA**

PARAMETER	SYMBOL	RATING	UNIT	
Junction to Ambient	$\theta_{JA}$	62.5	°C/W	
Junction to Case	$\theta_{JC}$	3.12	°C/W	

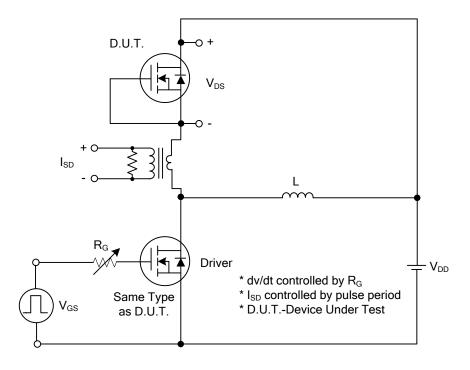
#### ■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub>=25°C, unless otherwise specified)

DADAMETED							
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	$V_{GS}$ =0V, $I_D$ =250 $\mu$ A	500			V
Drain-Source Leakage Current		I <sub>DSS</sub>	$V_{DS}$ =500V, $V_{GS}$ =0V			10	μΑ
Gate- Source Leakage Current	Forward		$V_{GS}$ =30V, $V_{DS}$ =0V			100	nA
	Reverse	I <sub>GSS</sub>	$V_{GS}$ =-30V, $V_{DS}$ =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =7.5A			0.45	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance	nput Capacitance				1650		рF
Output Capacitance		C <sub>ISS</sub>	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHz		185		pF
Reverse Transfer Capacitance		C <sub>RSS</sub>			16		pF
SWITCHING CHARACTERISTICS	3						
Total Gate Charge (Note 1)		$Q_{G}$	\/ -400\/ \/ -10\/   -15A		40		nC
Gate-Source Charge		$Q_GS$	V <sub>DS</sub> =400V, V <sub>GS</sub> =10V, I <sub>D</sub> =15A		9		nC
Gate-Drain Charge		$Q_GD$	I <sub>G</sub> =1mA (Note 1, 2)		12		nC
Turn-On Delay Time (Note 1)		t <sub>D(ON)</sub>			28		ns
Turn-On Rise Time		t <sub>R</sub>	V <sub>DS</sub> =100V, V <sub>GS</sub> =10V, I <sub>D</sub> =15A,		25		ns
Turn-Off Delay Time		t <sub>D(OFF)</sub>	R <sub>G</sub> =25Ω (Note 1, 2)		105		ns
Turn-Off Fall Time		$t_{F}$			30		ns
DRAIN-SOURCE DIODE CHARA	CTERISTICS	AND MAXII	MUM RATINGS				
Maximum Body-Diode Continuous Current		Is				15	Α
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>				30	Α
Drain-Source Diode Forward Voltage (Note 1)		$V_{SD}$	I <sub>S</sub> =15A , V <sub>GS</sub> =0V			1.4	V
Reverse Recovery Time (Note 1)		t <sub>rr</sub>	I <sub>S</sub> =15A , V <sub>GS</sub> =0V		360		ns
Reverse Recovery Charge		Q <sub>rr</sub>	di/dt=100A/µs		10		μC

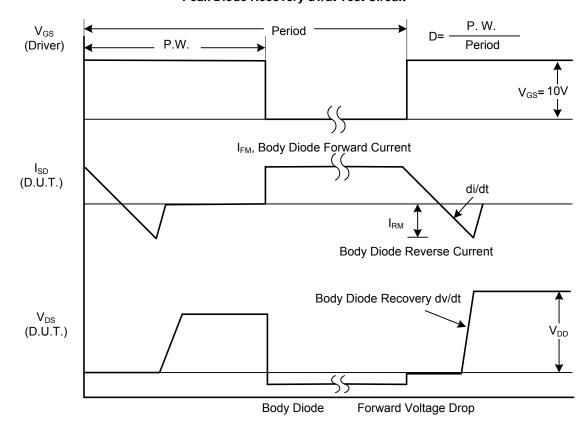
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

#### **■ TEST CIRCUITS AND WAVEFORMS**



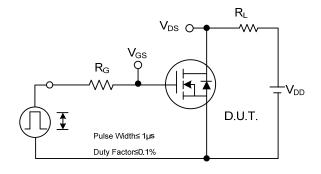
# Peak Diode Recovery dv/dt Test Circuit

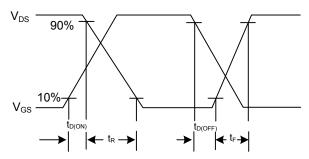


Peak Diode Recovery dv/dt Waveforms

15N50-MH Power MOSFET

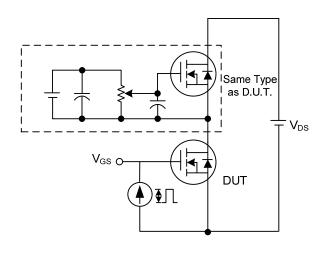
# ■ TEST CIRCUITS AND WAVEFORMS

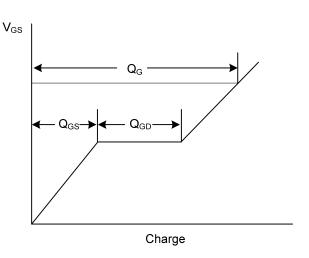




**Switching Test Circuit** 

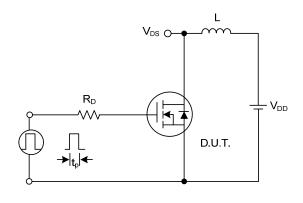
**Switching Waveforms** 

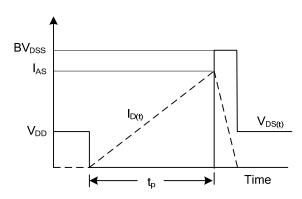




**Gate Charge Test Circuit** 

**Gate Charge Waveform** 

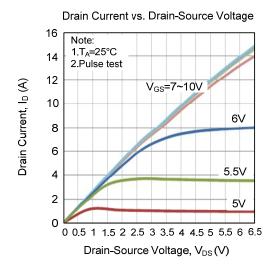


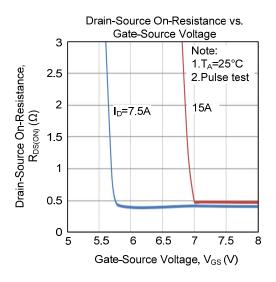


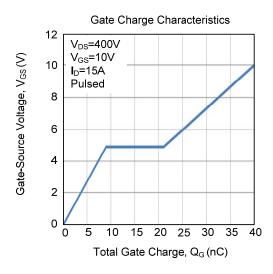
**Unclamped Inductive Switching Test Circuit** 

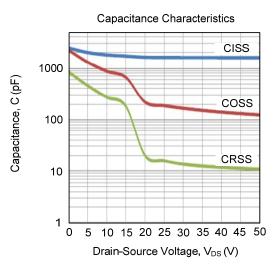
**Unclamped Inductive Switching Waveforms** 

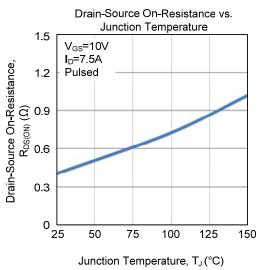
#### **■ TYPICAL CHARACTERISTICS**

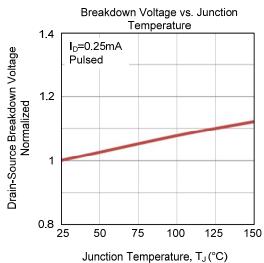




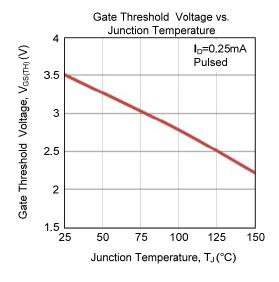


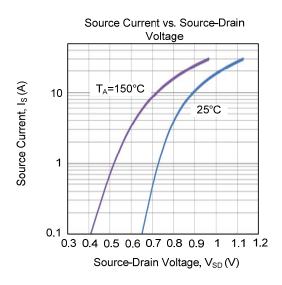


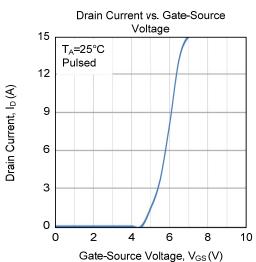


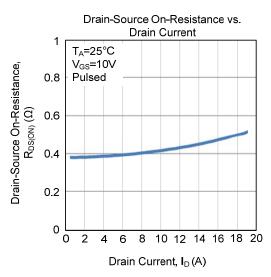


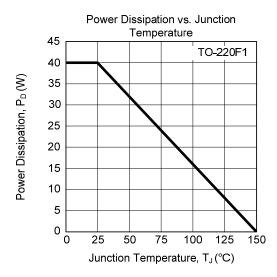
# **■ TYPICAL CHARACTERISTICS (Cont.)**

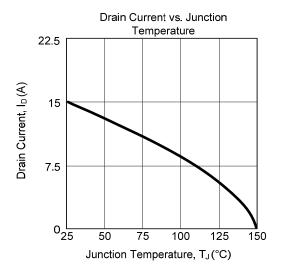




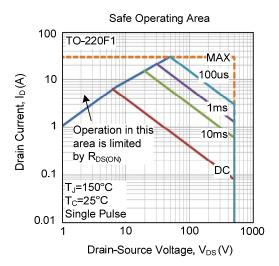








# **■ TYPICAL CHARACTERISTICS (Cont.)**



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